TOSHIBA TPD1034F

> TOSHIBA INTELLIGENT POWER DEVICE SILICON MONOLITHIC POWER MOS INTEGRATED CIRCUIT

T P D 1 0 3 4 F

HIGH-SIDE POWER SWITCH for MOTORS, SOLENOIDS, and LAMP **DRIVERS**

TPD1034F is a monolithic power IC for high-side switches. The IC has a vertical MOS FET output which can be directly driven from a CMOS or TTL logic circuit (eg, an MPU). The device offers intelligent self-protection and diagnostic functions.

FEATURES

- A monolithic power IC with a new structure combining a control block (Bi-CMOS) and a vertical power MOS FET (π -MOS) on a single chip.
- One side of load can be grounded to a high-side switch.
- Can directly drive a power load from a microprocessor.
- Built-in protection against overheating and load short circuiting.
- Incorporates a diagnosis function that allows diagnosis output to be read externally at load short circuiting, opening, or overheating.
- Up to -10V of counterelectromotive force from an L load can be applied.
- Low on resistance : $R_{ON} = 80 \,\mathrm{m}\Omega$ (Max)
- Low operating current : $I_{DD} = 1 \text{ mA}$ (Typ.), at $V_{DD} = 12 \text{ V}$, $V_{IN} = 0$
- 8-pin SOP package for surface mounting can be packed in tape.

(Note): That because of its MOS structure, this product is sensitive to static electricity.

The information contained herein is subject to change without notice.

SOP8-P-1.27A

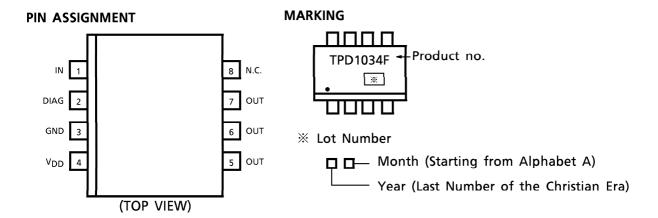
Weight: 0.08 g (Typ.)

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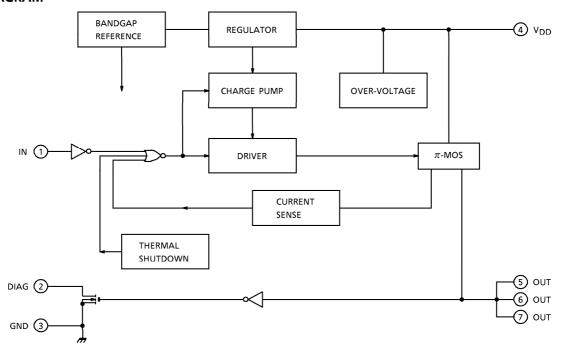
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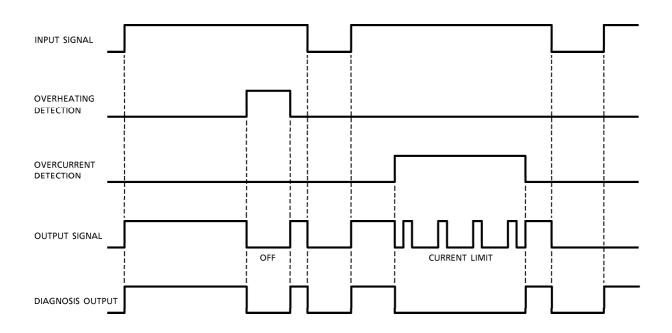
BLOCK DIAGRAM



PIN DESCRIPTION

PIN No.	SYMBOL	FUNCTION
1	IN	Input is CMOS-compatible, with pull-down resistor connected. Even if the input is open, output will not accidentally turn on.
2	DIAG	Self-diagnosis detection pin. Goes low when overheating is detected or when output is short circuited with input on (high). N-channel open drain.
3	GND	Ground pin.
4	V_{DD}	Power pin.
5, 6, 7	ОИТ	Output pin. When the load is short circuited and current in excess of the detection current (24A Typ.) flows to the output pin, the output automatically turns on or off.

TIMING CHART



TRUTH TABLE

INPUT SIGNAL	OUTPUT SIGNAL	DIAGNOSIS OUTPUT	STATE
Н	Н	Н	Normal
L	L	L	NOTITIAL
Н	L	L	Load short circuited
L	L	L	Load Short circuited
Н	Н	Н	Load open
L	Н	Н	Load open
Н	Ĺ	Ĺ	Overheating
Ĺ	Ĺ	Ĺ	Overneating

MAXIMUM RATINGS ($Ta = 25^{\circ}C$)

CHARACTERIS	STIC	SYMBOL	RATING	UNIT	
Drain-source Voltage	е	V _{DS}	60	V	
C. mml. Valtana	DC	V _{DD} (1)	25	٧	
Supply Voltage	Pulse	V _{DD} (2)			
Input Voltage	DC	V _{IN} (1)	-0.5~12	٧	
Input voltage	Pulse	V _{IN} (2)	$V_{DD(1)} + 1.5 (t = 100 ms)$	V	
Diagnosis Output Voltage		V _{DIAG}	-0.5~25	V	
Output Current		lo	Internally Limited	Α	
Input Current		IN	± 10	mA	
Diagnosis Output Co	urrent	IDIAG	5	mA	
Power Dissipation (Ta = 25°C)		PD	1.4 (Note 1)	w	
Power Dissipation (1	a = 25 C	ן יט	2.4 (Note 2)	VV	
Operating Temperature		T _{opr}	-40~110	°C	
Junction Temperatu	re	Tj	150	°C	
Storage Temperatur	e	T _{stg}	- 55~150	°C	
Lead Temperature / 1	time	T _{SOL}	275 (5 s), 260 (10 s)	°C	

THERMAL RESISTANCE

CHARACTERISTIC	SYMBOL	TEST CONDITION	UNIT	
Thermal Resistance	D.1 (1)	89.3 (Note 1)	°C/W	
Thermal Resistance	Kth (j-a)	52.1 (Note 2)] [, , , ,	

(Note 1) : Mounted on glass epoxy board (1 inch 2 x 0.8 t) (DC)

(Note 2) : Mounted on glass epoxy board (1 inch² \times 0.8 t) (t $_{\mbox{W}} \leq$ 10 s)

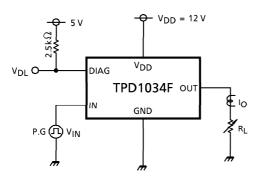
ELECTRICAL CHARACTERISTICS (Unless otherwise specified, $Tc = -40 \sim 110^{\circ}C$, $V_{DD} = 8 \sim 18 \text{ V}$)

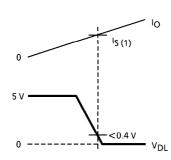
CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Operating Sup	ply Voltag	V _{DD} (OPR)	_	_	5	12	18	V
Current Dissip	ation	lDD	_	$V_{DD} = 12 V, V_{IN} = 0$	_	1	5	mA
Innert Valtage		V _{IH}	_	V _{DD} = 12 V, I _O = 8 A	3.5	_	_	V
Input Voltage		V _{IL}	_	$V_{DD} = 12 \text{ V}, I_{O} = 1.2 \text{ mA}$	_	_	1.5	V
Innut Current	Land Comment		_	$V_{DD} = 12 \text{ V}, V_{IN} = 5 \text{ V}$	_	50	200	μΑ
Input Current		I _{IN} (2)	_	$V_{DD} = 12 V, V_{IN} = 0$	- 0.2	_	0.2	μΑ
On Voltage		V _{DS} (ON)	_	$V_{DD} = 12 \text{ V}, I_{O} = 8 \text{ A},$ $Tc = 25^{\circ}\text{C}$	_	_	0.64	٧
On Resistance		R _{DS} (ON)	_	V _{DD} = 12 V, I _O = 8 A, Tc = 25°C	_	_	0.08	Ω
Output Leaka	ge Current	lOL	_	V _{DD} = 18 V, V _{IN} = 0	_	_	1.2	mA
Diagnosis Out Voltage	1	V _{DL}	_	V _{DD} = 12 V, I _{DL} = 2 mA	_	_	0.4	٧
Diagnosis Out Current	put "H" Level	IDH	_	V _{DD} = 18 V, V _{DH} = 18 V	_	_	10	μΑ
Oversument D			1	V _{DD} = 12 V, Tc = 25°C	8	12	_	Α
Overcurrent Detection		I _S (2) (Note 4)	2		15	24	-	Α
Overheating	Temperature	Ts	_		150	160	200	°C
Detection	Hysteresis	∆Ts	_	<u> </u>	_	10	_	°C
Open Detection Resistance		Rops	_	V _{DD} = 8 V	1	50	100	$\mathbf{k}\Omega$
Switching Time tON tOFF			3	V_{DD} = 12 V, R_L = 5 Ω ,	10	200	_	μ s
			3	Tc = 25°C	10	30		μs

(Note 3) : $I_{S(1)}$ Overcurrent detection value when load is short circuited and $V_{IN} = "L" \rightarrow "H"$ (Note 4) : Overcurrent detection value when load current is increased while $V_{IN} = "H"$

TEST CIRCUIT 1

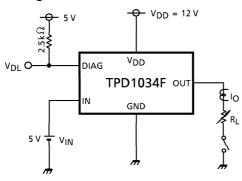
Over-voltage detection

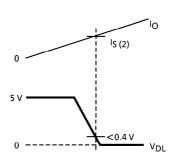




TEST CIRCUIT 2

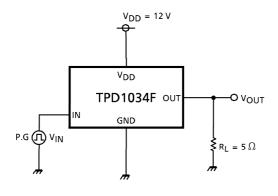
Over-voltage detection

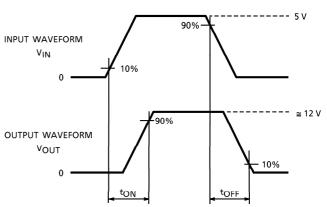


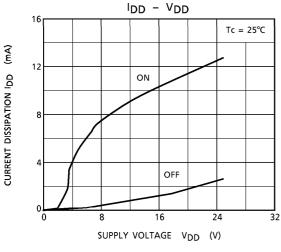


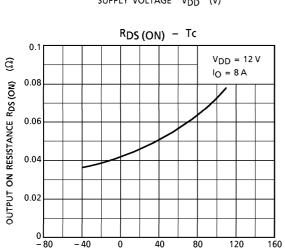
TEST CIRCUIT 3

Switching time

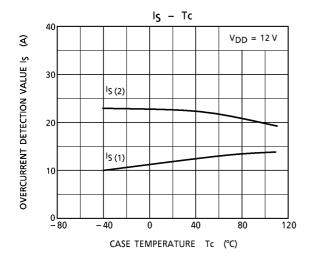


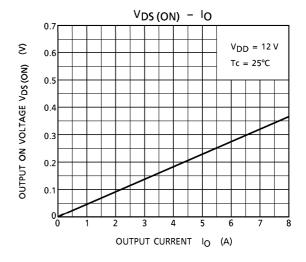


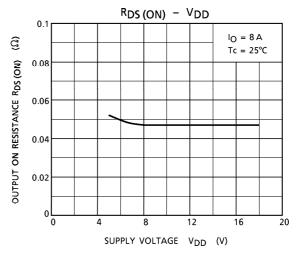


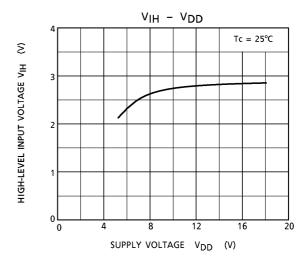


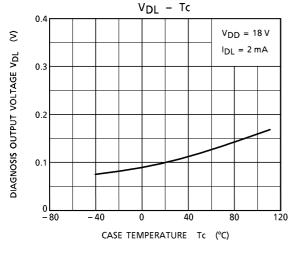
CASE TEMPERATURE Tc (°C)

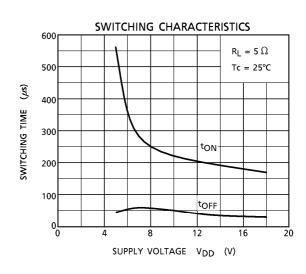


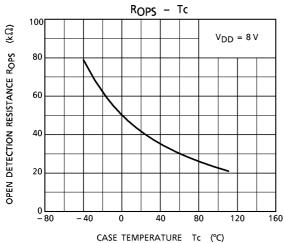


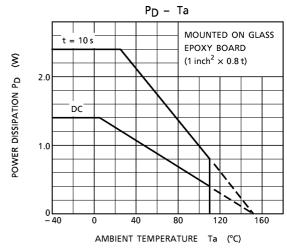


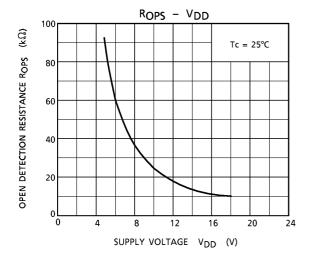






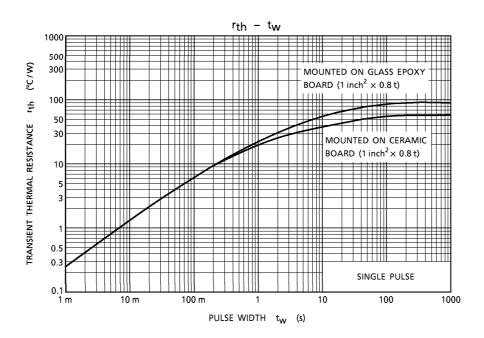






PRECAUTION:

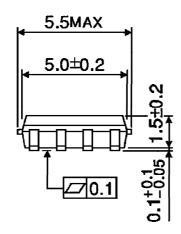
1. Since protection for, for example, reverse connection of the battery is not provided, provide protection using external circuits.

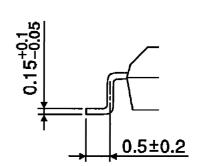


Unit: mm

PACKAGE DIMENSIONS

0.595TYP 0.4±0.1 0.25 W





Weight: 0.08 g (Typ.)